Enhanced structural and magnetic ordering of FePt/TiOₓ bilayers by ion-beam deposition and annealing

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1. Introduction

The superparamagnetic effect of magnetic materials is the main obstacle limiting the increase of magnetic recording density. Typical recording media used these days, such as CoCrPt-based recording media, have poor thermal stability at nanometer scales [1]. Magnetocrystalline anisotropy and grain sizes are the two main factors influencing the thermal stability of a recording medium. Magnetic materials with high magnetocrystalline anisotropy are frequently investigated, such as FePt and CoPt [2–7]. Stoichiometric FePt has two phases at room temperature, fcc phase and fct phase. Fcc phase FePt is superparamagnetic at nanometer scale and it can be synthesized by sputtering. Fct phase FePt is ferromagnetic even in the form of nanoparticles with size down to 4 nm; however, fct–FePt cannot be directly synthesized but must be transformed from fcc phase FePt through annealing [8–16].

The presence of a capping layer can also influence the transformation from fcc to fct-phase of the underlying FePt layer. SiO₂ [18,19], Al₂O₃ [20], Cu [21,22] have been investigated as the capping layer of FePt during annealing. With a single SiO₂ capping layer, 400 °C was sufficient to transform the FePt fcc phase into the fct phase [18]. A 4-nm Cu capping layer, on the other hand, could raise the coercivity of FePt drastically from 3100 Oe to 6000 Oe [22]. Our previous work in FePt/MnOₓ has shown that in the reference pure FePt layer, annealing will result in the structure ordering from fcc to fct [23]. TiOₓ is also a common capping layer which is very active at diffusion during annealing [24–26]. The interdiffusion between TiOₓ and FePt driven by dynamic thermal energy [27] might result in the FePt grains separated by TiOₓ boundaries [28]. However, the influence of these high annealing temperatures on the magnetic properties of the TiOₓ capped FePt has not been investigated.

In this paper, we investigate the annealing temperature influence on the microstructure and magnetic properties of FePt/TiOₓ bilayer. The XRD diffraction patterns, surface morphologies, and magnetic hysteresis measurements of FePt/TiOₓ bilayers annealed at different temperatures were studied. Coercivity over 11 kOe has been obtained, which can have important applications in magnetic data recording.
cleaned with acetone and deionized (DI) water with sonication. Fe and Pt were co-sputtered on the substrate with DC power of 70 W and 33 W, respectively, with the sample stage rotating at 10 rpm/ min to form a stoichiometric FePt film with thickness of 10 nm. The base pressure was $8 \times 10^{-9}$ Torr, and the sputtering Ar pressure was 10 mTorr. A Kaufman source was used to focus the argon ion beam onto a commercial Ti target surface, and an End-Hall source was used to sputter the capping TiO$_2$ layer. The O$_2$/Ar ratio in the End-Hall ion source was fixed at 30%. No external magnetic field was applied during deposition. The samples were then annealed at 300 °C, 400 °C, 550 °C and 650 °C for 10 min. The crystallinity of the FePt/TiO$_2$ thin films was characterized by grain size X-ray diffraction with a Cu $K_x$ source. A JEOL JEM-2010 transmission electron microscopy (TEM) system operating at 200 kV was used for the surface morphology and cross-section characterization. Grain sizes were measured from the TEM images by using an image-analysis software - Image J. Ferromagnetic properties of as-deposited and annealed samples were measured with a LakeShore - 7407 vibrating sample magnetometer (VSM). Surface roughness characterization was carried out using a commercial atomic force microscope (AFM) system.

3. Results and discussion

As-deposited FePt in FePt/TiO$_2$ bilayers exhibited a preferred (111) orientation with a lattice constant of $a \approx 3.76$ Å as shown in the XRD pattern in Fig. 1. The fcc (001) peak at 25° and the fct (110) peak at 33°, both being the signature peaks of FePt fct phase [29], are not observed in the as-deposited XRD diffraction in Fig. 1, indicating the absence of the FePt fct phase. As the annealing temperature is increased to 300 °C, the fcc (001) and (110) peaks were still not observed, while the (111) peaks were still observed with a lattice constant of $a \approx 3.78$ Å. However, annealing at higher temperatures ranging from 400 °C to 650 °C led to a FePt phase transformation from fcc to fct, as evidenced by the appearance of the (001) and (110) fct peaks in the XRD patterns for samples annealed at 400 °C, 550 °C and 650 °C in Fig. 1. Fct (001) and (200) peaks were observed at 400 °C, and enhanced intensities of these two peaks were found at 550 °C and 650 °C, indicating the fct phase transformation is enhanced as the annealing temperature increased. The amount of fct phase can be implied by using the order parameters [30] of fct phase FePt, which was calculated by

$$S = \sqrt{\frac{I_{(111)} / I_{(111)}}{I_{(110)} / I_{(111)}}}$$

where the $I_{(110)}$ and $I_{(111)}$ stands for the intensity of the XRD peak of fct phase (110) and (111) phases, the numerators are experimentally measured from the sample and the denominators are the calculated results from an ideal sample with order parameter $S = 1$.

The effect of the TiO$_2$ capping layer on microstructure and magnetic properties of FePt was studied by analyzing the interfaces. To understand the microstructure and surface morphology of the samples, high-resolution TEM (HRTEM) was used to characterize the FePt/TiO$_2$ bilayers. Bright field images and the electron diffraction patterns of FePt/TiO$_2$ bilayers, after annealing at different temperatures, are displayed in Fig. 2. The electron diffraction patterns are found to be the mixed structures of fcc and fct FePt phases; however, the appearance of the fct phase feature peaks such as fct phase (001) and (002) indicate the phase transformation from fcc to fct FePt even though the films may still be mixture of fcc and fct phases. As-deposited FePt/TiO$_2$ bilayers exhibit a polycrystalline structure with grain sizes ranging from 5 to 12 nm, as measured from Fig. 2(a). Polycrystalline structure can be observed in the as-deposited FePt/TiO$_2$, as indicated in the electron diffraction pattern in the inset of Fig. 2(a). The grain size grew significantly to the range of 16–40 nm after annealing at 400 °C for 10 min (Fig. 2(b)). Ordered fct FePt phases as indexed by electron diffraction patterns are observed in the inset of Fig. 2(b), indicating that there is more fct phase formation than the as-deposited sample, where no obvious fct phase was observed. Similar surface morphology is also observed in FePt/TiO$_2$ bilayers after annealing at 550 °C, with a wider

![Fig. 1. XRD diffraction patterns of FePt/TiO$_2$ bilayer with different annealing temperatures. Labels are identified by the JCPDS card.](image-url)
grain size distribution ranging from 6 nm to 50 nm (Fig. 2(c)). Fct phases such as (201) and (112) orientations are observed in the electron diffraction patterns in the inset of Fig. 2(c), indicating more fct phase formation after annealing at 550 °C for 10 min compared with previous samples annealed with lower temperatures. In contrast, after annealing at 650 °C for 10 min, separated grains appear with similar sizes as shown in Fig. 2(d). Electron diffraction patterns in the inset of Fig. 2(d) exhibit (002), (202), and (113) orientations of fct phase shown in the inset of Fig. 2(d), indicating there is much more fct phase formed than the previous ones. The grain size distribution after annealing at 650 °C is plotted in Fig. 3 and the grain sizes mostly concentrate in the range from 5 nm to 8 nm. This grain size distribution is narrower than the distributions in the other samples annealed at lower temperatures.

In order to investigate the influence of TiO$_x$ diffusion into FePt on the microstructure of bilayers, TEM cross-section characterization was performed and the results are shown in Fig. 4. As-deposited FePt/TiO$_x$ bilayer exhibits a clear interface separating the 10 nm FePt and 9 nm TiO$_x$ films (Fig. 4(a)). When the annealing temperature is increased, the interface between FePt and TiO$_x$ layer becomes less clear. The TEM cross-section image of interface of FePt/TiO$_x$ bilayer after annealing at 400 °C is shown in Fig. 4(b) and the interface between FePt and TiO$_x$ becomes graded. After annealing at 550 °C, the interface in Fig. 4(c) becomes less evident and FePt and TiO$_x$ layers almost mix together. This result indicates that as the annealing temperature is increased, there is enhanced diffusion at the FePt and TiO$_x$ interface. FePt/TiO$_x$ bilayer after annealing at 650 °C for 10 min exhibited the most graded interface (Fig. 4(d)), indicating there was strong diffusion at the FePt and TiO$_x$ interface and there was even diffusion between FePt and substrate.

Fig. 2. Bright field images and electron diffraction patterns of FePt/TiO$_x$ bilayer with different annealing temperatures. (a) As-deposited (b) 400 °C (c) 550 °C (d) 650 °C.

Fig. 3. Grain size distribution of FePt/TiO$_x$ after annealing at 650 °C for 10 min.
SiO$_2$. Thus the small grain sizes are mainly contributed by the diffusion in Figs. 2(d) and 3 after annealing at 650 °C for 10 min.

To further investigate the extent of diffusion between FePt and TiO$_x$ layers, X-ray photoelectron spectroscopy (XPS) was performed and the depth profile is shown in Fig. 5 as a function of sputter time where the layer boundaries were decided by the atomic concentration. In the figure, the x-axis corresponds to the sputtering time and the y-axis is the atomic concentration of each element obtained using atomic sensitive factor. The XPS results have shown the similar 50–50 atomic composition in Fe and Pt qualitatively.
as in [31]. As-deposited FePt/TiO$_2$ bilayer (Fig. 5(a)) shows a sharp transition at 0.5 min, around which Ti and O concentrations drop strongly and the Fe and Pt contents show marked increases. As the annealing temperature is increased to 400 °C, the transition becomes less distinct and moved left to 0.3 min in Fig. 5(b). There is Fe and Pt observed to the left of the interface, indicating that some FePt already diffused into TiO$_2$ after annealing at 400 °C. As the annealing temperature further increased to 550 °C more Fe and Pt can be observed over a wider range of sputtering time (from 0 min to 0.3 min), indicating more FePt diffused into TiO$_2$ after annealing at 550 °C compared with the previous samples annealed at lower temperatures. For the sample annealed at 650 °C (Fig. 5(d)), the interface widened even more and moved further left to 0.2 min. Different from the previous XPS data for samples with lower annealing temperatures (where a sharp interface could be observed), the Ti, O, Fe and Pt are observed over the whole bilayer sample, indicating that there is strong diffusion both from FePt into TiO$_2$ and vice versa.

The surface morphology of FePt/TiO$_2$ bilayer was also investigated with atomic force microscopy with a scanning area of 2 × 2 μm. The roughness of sample surface with different annealing temperatures is given in Table 1. As the annealing temperature is increased from room temperature to 650 °C, the surface roughness first slightly decreases to 0.34 nm at 300 °C, and then increases up to 1.21 nm at 650 °C. This result indicates that annealing temperature higher than 300 °C leads to the formation and grain growth of fct phase FePt, implying a surface roughness increase.

<table>
<thead>
<tr>
<th>$T$ (°C)</th>
<th>25</th>
<th>300</th>
<th>400</th>
<th>550</th>
<th>650</th>
</tr>
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<tbody>
<tr>
<td>Roughness (nm) (scanning area: 2 × 2 μm)</td>
<td>0.38</td>
<td>0.34</td>
<td>0.51</td>
<td>0.51</td>
<td>1.21</td>
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**Fig. 6.** Coercivity and annealing temperature relationship of FePt/TiO$_2$ bilayer after annealing at different temperatures.

11.4 ± 0.2 kOe in the out-of-plane direction and 11.7 ± 0.2 kOe in the in-plane direction after annealing at 650 °C for 10 min were achieved.

The above results show that through annealing, the ordering of FePt can be achieved from fcc to fct phase. Meanwhile, the interdiffusion can effectively separate the FePt grains with TiO$_2$. Compared to other oxides, such as SiO$_2$ [32] and MnO$_2$ [23], the TiO$_2$ has different impacts on the magnetic properties due to different reactivity and interdiffusion with FePt layers. The active diffusion of TiO$_2$ can effectively constitute TiO$_2$ boundaries and separate the FePt grains to form granular-structured FePt films [23,32], which may have important applications in future high-density magnetic recording media.

4. Conclusion

The influence of annealing temperature on the microstructure and magnetic properties of FePt/TiO$_2$ bilayers was investigated. The magnetic properties and microstructure of FePt capped with TiO$_2$ layer could be modified with annealing temperature. The different annealing temperature influences the FePt structure by transforming it from fcc to fct phase and also by diffusing TiO$_2$ into FePt as oxides boundaries during annealing. Highest coercivities with 11.4 ± 0.2 kOe in the out-of-plane direction and 11.7 ± 0.2 kOe in the in-plane direction after annealing at 650 °C for 10 min were achieved. Annealing at 650 °C was sufficient to transform FePt fcc into fct phase and also caused TiO$_2$ diffusing into FePt, separating the continuous FePt thin films into individual grains.

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